

MATSUSHITA ELECTRONIC



Client:

Matsushita Electronic Materials, Inc.

Facility Type:

Circuit Board Manufacturing Facility

Location:

Portland, Oregon

Size:

82,000 s.f.

Construction Date:

July 1992 - October 1993

Overview:

The Matsushita Electronic Materials facility comprises an 82,000 s.f. manufacturing facility of circuit board copper-clad laminates. The project houses and extremely technical, process-oriented manufacturing facility. Special design considerations were required to accommodate the installation of process equipment six-stories high. Also key for Shimizu North America was resolving the environment and building code issues associated with the plant's hazardous manufacturing materials in order to ensure the safety and comfort of the surrounding community.